



RECOMMENDED P.C.B LAYOUT

SPECIFICATIONS

1. D-SUB
- 1.1 Voltage: 250 VAC(RMS) Max.
- 1.2 Current Rating: 3 Ampere per Contact
- 1.3 Contact Resistance: 25 Milliohms Max.
- 1.4 Insulation Resistance: 5000 Megohms Min.
- 1.5 Dielectric Withstanding Voltage: 1000 VAC(RMS)
- 1.6 Total Mating Force: 9.7 Kgf Max.
- 1.7 Total Unmating Force: 1.4 Kgf Min.
- 1.8 Operating Temperature: -55°C to +85°C

NOTES

1. MATERIAL:
 - Housing:PBT, UL 94V-0, Color:Black.
 - Terminal:Copper Alloy.
 - Shell:SPCC.
 - Boardlock:Copper Alloy.
 - Bracket:Zinc Alloy.
2. FINISH:
 - Terminal:Gold Plated over Nickel at Contact Area.
 - Tin Plated over Nickel at Solder Ared.
 - Shell:Nickel Plated.
 - Boardlock:Tin Plated.
 - Bracket:Nickel Plated.
3. This Product is LEAD-FREE & RoHS Compliance Product.



Champyang International Ltd., Co

A0	RELEASED	Allen	2019-10-04
REV	DESCRIPTION.	APPD.	Date

FILE NO : ADA05 (Series)		TITLE 圖名		D-SUB HIGH DENSITY CONNECTOR 0.350*(8.89) FOOTPRINT, DUAL PORT		UNIT 單位	mm inch
TOLERANCE(公差): 0.000 mm ± 0.13 mm 0.00 mm ± 0.25 mm Ang: 0.0 = ±2°		PART NO. 料號		ADA10-7S7SB-1x2D112N0		SCALE 比例	1:1
DRAWN BY 製圖		Ben		DATE 日期		2019-10-04	
CHECKED BY 審核		Allen		DATE 日期		2019-10-04	
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